



CY7C4421/4201/4211/4221

CY7C4231/4241/4251

64/256/512/1K/2K/4K/8K x 9

Synchronous FIFOs

Features

- 64 x 9 (CY7C4421)
- 256 x 9 (CY7C4201)
- 512 x 9 (CY7C4211)
- 1K x 9 (CY7C4221)
- 2K x 9 (CY7C4231)
- 4K x 9 (CY7C4241)
- 8K x 9 (CY7C4251)
- High-speed 100-MHz operation (10 ns read/write cycle time)
- Pin compatible and functionally equivalent to IDT72421, 72201, 72211, 72221, 72231, 72241
- Fully asynchronous and simultaneous read and write operation
- Four status flags: Empty, Full, and programmable Almost Empty/Almost Full
- Expandable in width

- Low operating power
 $I_{CC1} = 50 \text{ mA}$
- Output Enable (\overline{OE}) pin
- 32-pin PLCC/TQFP

Functional Description

The CY7C42X1 are high-speed, low-power, first-in first-out (FIFO) memories with clocked read and write interfaces. All are 9 bits wide. The CY7C42X1 are pin-compatible to IDT722X1. The CY7C42X1 can be cascaded to increase FIFO depth. Programmable features include Almost Full/Almost Empty flags. These FIFOs provide solutions for a wide variety of data buffering needs, including high-speed data acquisition, multiprocessor interfaces, and communications buffering.

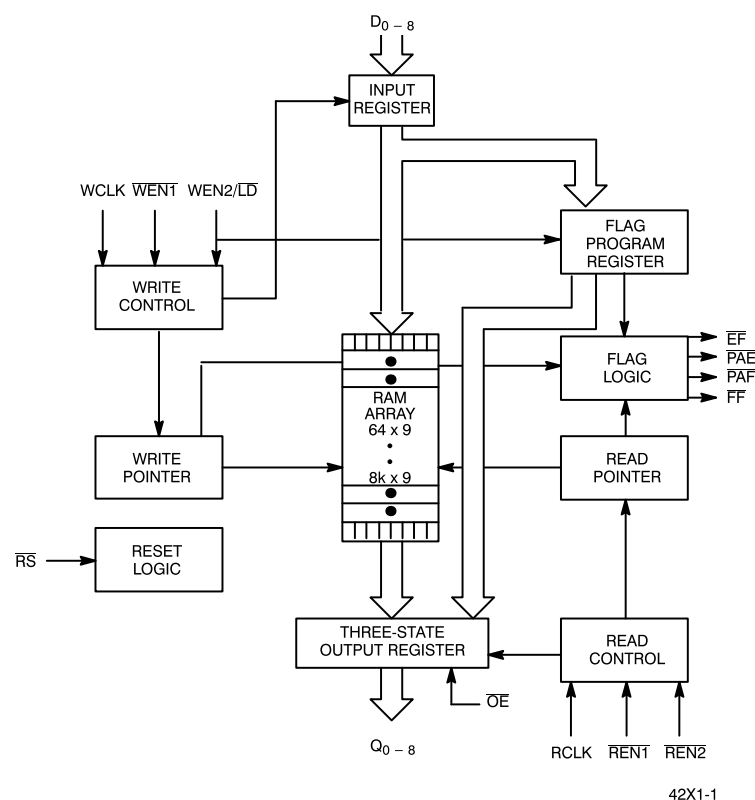
These FIFOs have 9-bit input and output ports that are controlled by separate clock and enable signals. The input port is controlled by a free-running clock (WCLK)

and two write-enable pins ($\overline{WEN1}$, $\overline{WEN2/\overline{LD}}$).

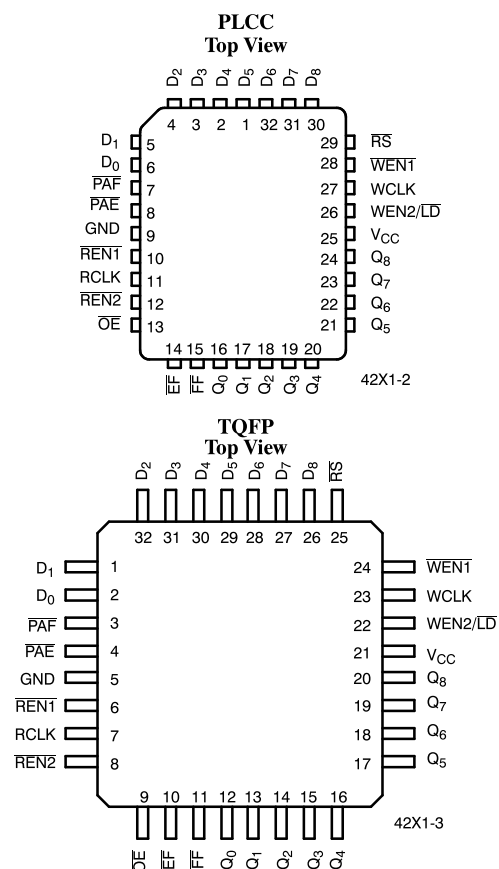
When $\overline{WEN1}$ is LOW and $\overline{WEN2/\overline{LD}}$ is HIGH, data is written into the FIFO on the rising edge of the WCLK signal. While $\overline{WEN1}$, $\overline{WEN2/\overline{LD}}$ is held active, data is continually written into the FIFO on each WCLK cycle. The output port is controlled in a similar manner by a free-running read clock (RCLK) and two read enable pins ($\overline{REN1}$, $\overline{REN2}$). In addition, the CY7C42X1 has an output enable pin (\overline{OE}). The read (RCLK) and write (WCLK) clocks may be tied together for single-clock operation or the two clocks may be run independently for asynchronous read/write applications. Clock frequencies up to 100 MHz are achievable.

Depth expansion is possible using one enable input for system control, while the other enable is controlled by expansion logic to direct the flow of data.

Logic Block Diagram



Pin Configuration





Functional Description (continued)

The CY7C42X1 provides four status pins: Empty, Full, Almost Empty, Almost Full. The Almost Empty/Almost Full flags are programmable to single word granularity. The programmable flags default to Empty-7 and Full-7.

The flags are synchronous, i.e., they change state relative to either the read clock (RCLK) or the write clock (WCLK). When entering

or exiting the Empty and Almost Empty states, the flags are updated exclusively by the RCLK. The flags denoting Almost Full, and Full states are updated exclusively by WCLK. The synchronous flag architecture guarantees that the flags maintain their status for at least one cycle

All configurations are fabricated using an advanced 0.65μ N-Well CMOS technology. Input ESD protection is greater than 2001V, and latch-up is prevented by the use of guard rings.

Selection Guide

		7C42X1-10	7C42X1-15	7C42X1-25	7C42X1-35
Maximum Frequency (MHz)		100	66.7	40	28.6
Maximum Access Time (ns)		8	10	15	20
Minimum Cycle Time (ns)		10	15	25	35
Minimum Data or Enable Set-Up (ns)		3	4	6	7
Minimum Data or Enable Hold (ns)		0.5	1	1	2
Maximum Flag Delay (ns)		8	10	15	20
Active Power Supply Current (I _{CC1}) (mA)	Commercial	50	50	50	50
	Industrial	70	70	70	70

	CY7C4421	CY7C4201	CY7C4211	CY7C4221	CY7C4231	CY7C4241	CY7C4251
Density	64 x 9	256 x 9	512 x 9	1K x 9	2K x 9	4K x 9	8K x 9

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to +150°C

Ambient Temperature with

Power Applied -55°C to +125°C

Supply Voltage to Ground Potential -0.5V to +7.0V

DC Voltage Applied to Outputs
in High Z State -0.5V to +7.0V

DC Input Voltage -3.0V to +7.0V

Output Current into Outputs (LOW) 20 mA

Static Discharge Voltage >2001V
(per MIL-STD-883, Method 3015)

Latch-Up Current >200 mA

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	5V ± 10%
Industrial ^[1]	-40°C to +85°C	5V ± 10%

Note:

1. T_A is the “instant on” case temperature.



Pin Definitions

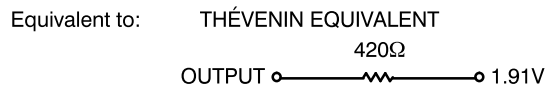
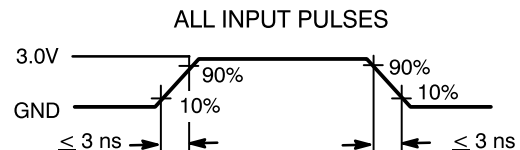
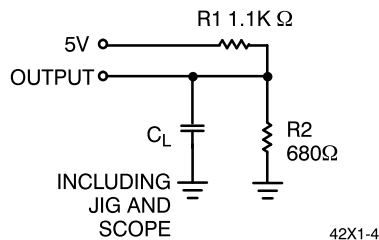
Signal Name	Description	I/O	Description
D ₀ – 8	Data Inputs	I	Data Inputs for 9-bit bus
Q ₀ – 8	Data Outputs	O	Data Outputs for 9-bit bus
WEN1	Write Enable 1	I	The only write enable when device is configured to have programmable flags. Data is written on a LOW-to-HIGH transition of WCLK when WEN1 is asserted and FF is HIGH. If the FIFO is configured to have two write enables, data is written on a LOW-to-HIGH transition of WCLK when WEN1 is LOW and WEN2/LD and FF are HIGH.
WEN2/LD Dual Mode Pin	Write Enable 2	I	If HIGH at reset, this pin operates as a second write enable. If LOW at reset, this pin operates as a control to write or read the programmable flag offsets. WEN1 must be LOW and WEN2 must be HIGH to write data into the FIFO. Data will not be written into the FIFO if the FF is LOW. If the FIFO is configured to have programmable flags, WEN2/LD is held LOW to write or read the programmable flag offsets.
	Load		
REN1, REN2	Read Enable Inputs	I	Enables the device for Read operation.
WCLK	Write Clock	I	The rising edge clocks data into the FIFO when WEN1 is LOW and WEN2/LD is HIGH and the FIFO is not Full. When LD is asserted, WCLK writes data into the programmable flag-offset register.
RCLK	Read Clock	I	The rising edge clocks data out of the FIFO when REN1 and REN2 are LOW and the FIFO is not Empty. When WEN2/LD is LOW, RCLK reads data out of the programmable flag-offset register.
EF	Empty Flag	O	When EF is LOW, the FIFO is empty. EF is synchronized to RCLK.
FF	Full Flag	O	When FF is LOW, the FIFO is full. FF is synchronized to WCLK.
PAE	Programmable Almost Empty	O	When PAE is LOW, the FIFO is almost empty based on the almost empty offset value programmed into the FIFO.
PAF	Programmable Almost Full	O	When PAF is LOW, the FIFO is almost full based on the almost full offset value programmed into the FIFO.
RS	Reset	I	Resets device to empty condition. A reset is required before an initial read or write operation after power-up.
OE	Output Enable	I	When OE is LOW, the FIFO's data outputs drive the bus to which they are connected. If OE is HIGH, the FIFO's outputs are in High Z (high-impedance) state.

Electrical Characteristics Over the Operating Range^[2]

Parameter	Description	Test Conditions	7C42X1-10		7C42X1-15		7C42X1-25		7C42X1-35		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -2.0 mA	2.4		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA		0.4		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage		2.2	V _{CC}	2.2	V _{CC}	2.2	V _{CC}	2.2	V _{CC}	V
V _{IL}	Input LOW Voltage		-3.0	0.8	-3.0	0.8	-3.0	0.8	-3.0	0.8	V
I _{IX}	Input Leakage Current	V _{CC} = Max.	-10	+10	-10	+10	-10	+10	-10	+10	μA
I _{OS} ^[3]	Output Short Circuit Current	V _{CC} = Max., V _{OUT} = GND	-90		-90		-90		-90		mA
I _{OZL} I _{OZH}	Output OFF, High Z Current	$\overline{OE} \geq V_{IH}$, V _{SS} < V _O < V _{CC}	-10	+10	-10	+10	-10	+10	-10	+10	μA
I _{CC1} ^[4]	Active Power Supply Current		Com'l	50		50		50		50	mA
			Ind	70		70		70		70	mA
I _{CC2} ^[5]	Average Standby Current		Com'l	30		28		25		22	mA
			Ind	40		38		35		35	mA
I _{CCfmax} ^[6]	Operating Current at Maximum Frequency		Com'l	150		130		75		60	mA
			Ind	170		150		95		80	mA

Capacitance^[7]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	5	pF
C _{OUT}	Output Capacitance		7	pF

AC Test Loads and Waveforms^[8, 9]

Notes:

- See the last page of this specification for Group A subgroup testing information.
- Test no more than one output at a time for not more than one second.
- Outputs open. Tested at Frequency = 20 MHz.
- All inputs = V_{CC} - 0.2V, except WCLK and RCLK, which are switching at maximum frequency..
- Input signals switch from 0V to 3V with a rise/fall time of less than 3 ns, clocks and clock enables switch at maximum frequency (f_{MAX}), while data inputs switch at f_{MAX}/2. Outputs are unloaded.
- Tested initially and after any design or process changes that may affect these parameters.
- C_L = 30 pF for all AC parameters except for t_{OHZ}.
- C_L = 5 pF for t_{OHZ}.



Switching Characteristics Over the Operating Range

Parameter	Description	7C42X1–10		7C42X1–15		7C42X1–25		7C42X1–35		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _S	Clock Cycle Frequency		100		66.7		40		28.6	MHz
t _A	Data Access Time	2	8	2	10	2	15	2	20	ns
t _{CLK}	Clock Cycle Time	10		15		25		35		ns
t _{CLKH}	Clock HIGH Time	4.5		6		10		14		ns
t _{CLKL}	Clock LOW Time	4.5		6		10		14		ns
t _{DS}	Data Set-Up Time	3		4		6		7		ns
t _{DH}	Data Hold Time	0.5		1		1		2		ns
t _{ENS}	Enable Set-Up Time	3		4		6		7		ns
t _{ENH}	Enable Hold Time	0.5		1		1		2		ns
t _{RS}	Reset Pulse Width ^[10]	10		15		25		35		ns
t _{RSS}	Reset Set-Up Time	8		10		15		20		ns
t _{RSR}	Reset Recovery Time	8		10		15		20		ns
t _{RSF}	Reset to Flag and Output Time		10		15		25		35	ns
t _{OLZ}	Output Enable to Output in Low Z ^[11]	0		0		0		0		ns
t _{OE}	Output Enable to Output Valid	3	7	3	8	3	12	3	15	ns
t _{OHZ}	Output Enable to Output in High Z ^[11]	3	7	3	8	3	12	3	15	ns
t _{WFF}	Write Clock to Full Flag		8		10		15		20	ns
t _{REF}	Read Clock to Empty Flag		8		10		15		20	ns
t _{PAF}	Clock to Programmable Almost-Full Flag		8		10		15		20	ns
t _{PAE}	Clock to Programmable Almost-Full Flag		8		10		15		20	ns
t _{SKEW1}	Skew Time between Read Clock and Write Clock for Empty Flag and Full Flag	5		6		10		12		ns
t _{SKEW2}	Skew Time between Read Clock and Write Clock for Almost-Empty Flag and Almost-Full Flag	10		15		18		20		ns

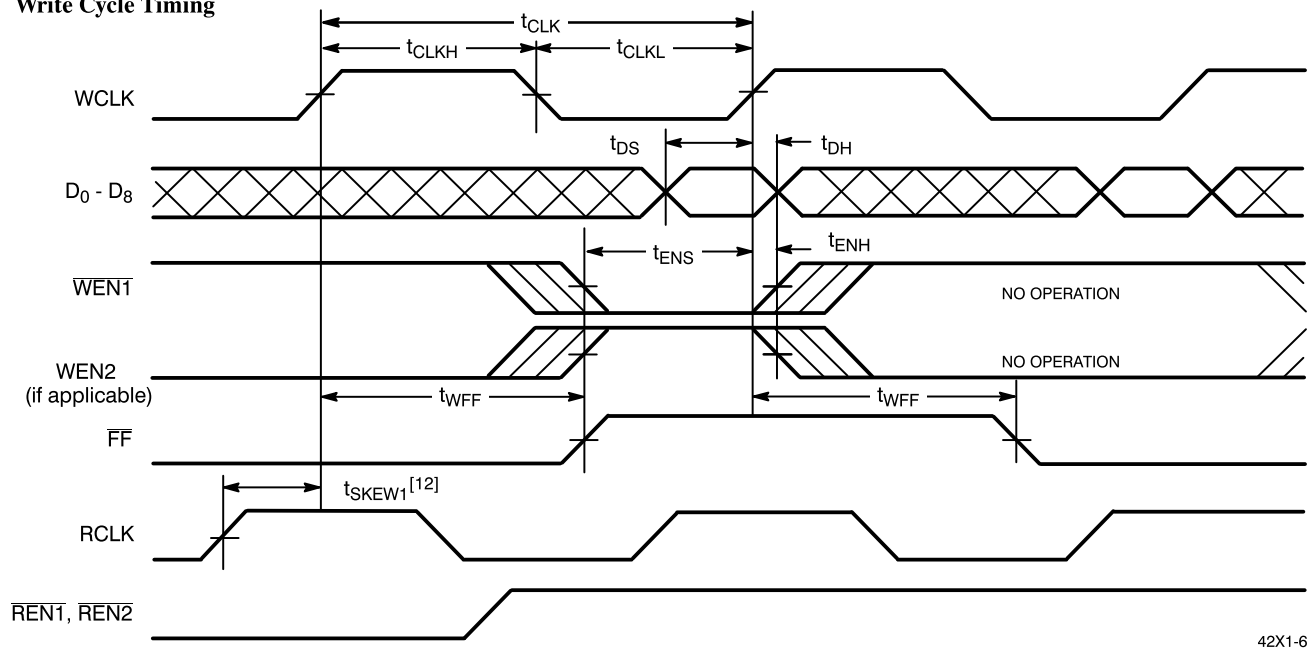
Notes:

10. Pulse widths less than minimum values are not allowed.

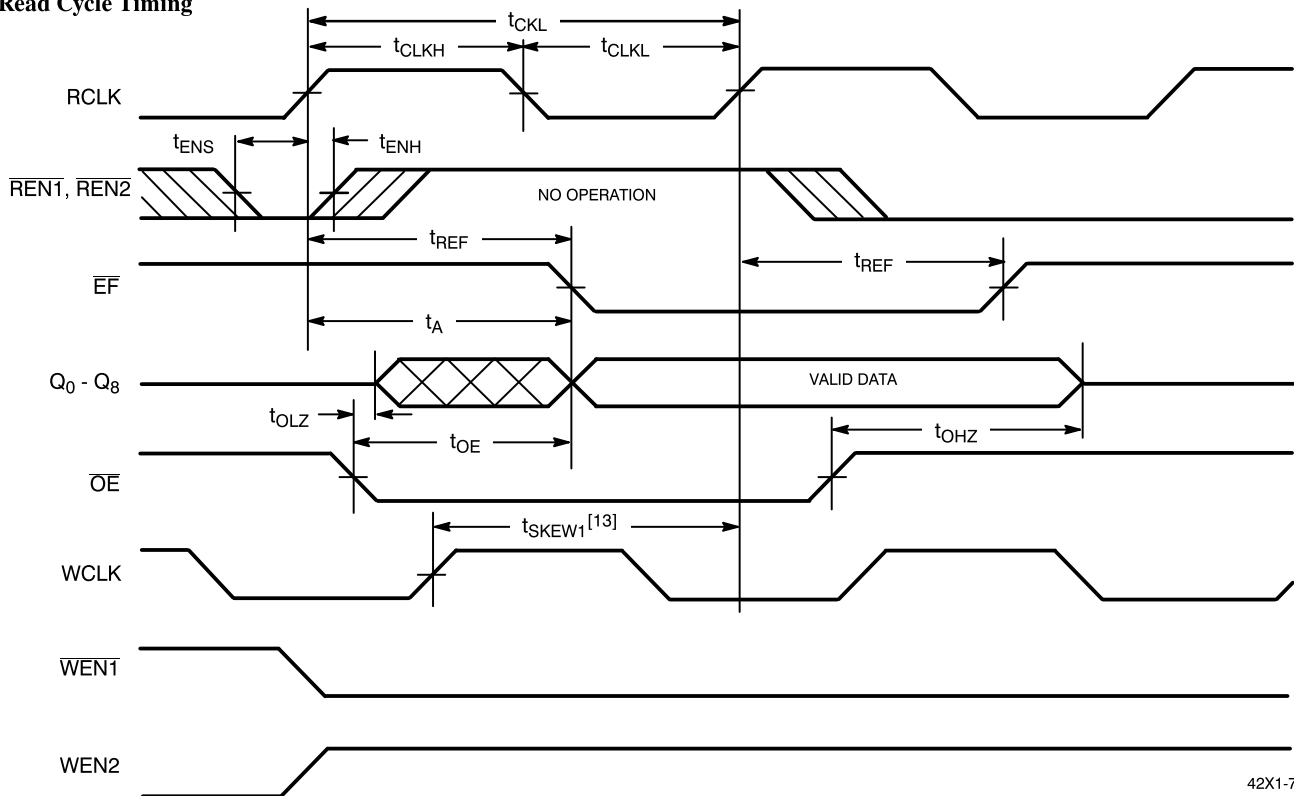
11. Values guaranteed by design, not currently tested.

Switching Waveforms

Write Cycle Timing

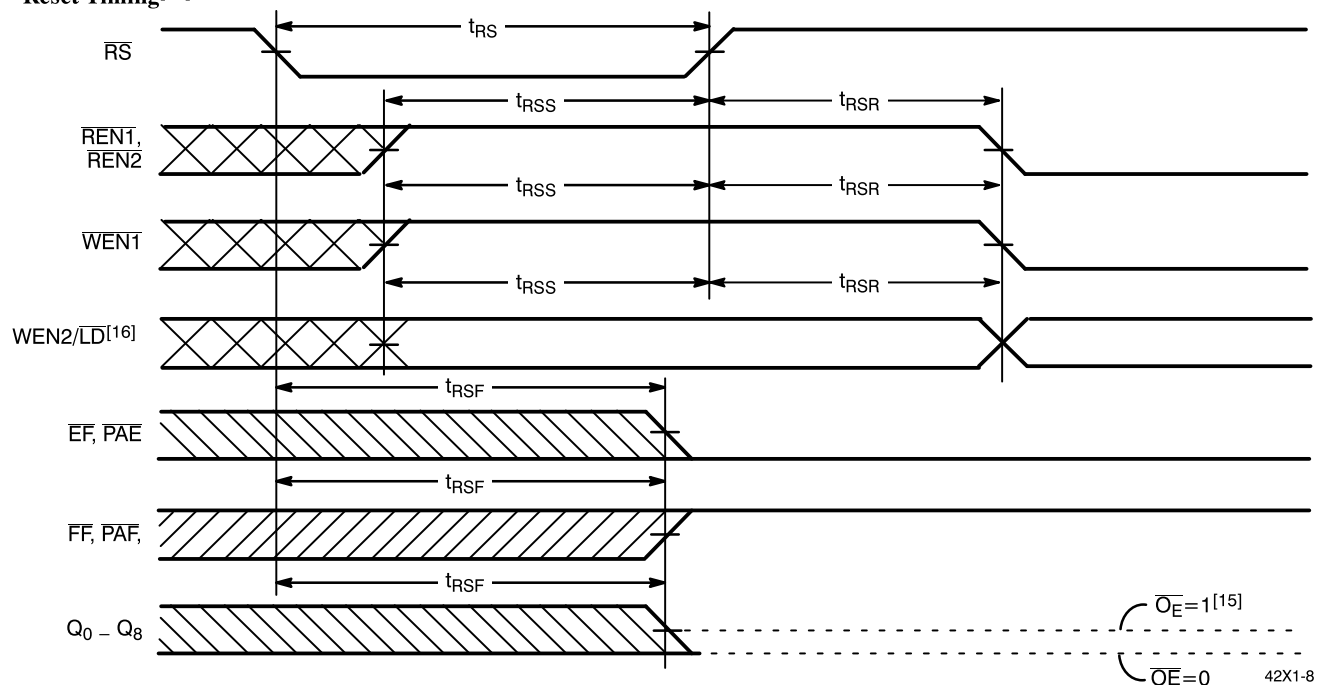


Read Cycle Timing



Notes:

12. t_{SKEW1} is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that \overline{FF} will go HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than t_{SKEW1} , then \overline{FF} may not change state until the next WCLK rising edge.
13. t_{SKEW1} is the minimum time between a rising WCLK edge and a rising RCLK edge to guarantee that \overline{EF} will go HIGH during the current clock cycle. If the time between the rising edge of WCLK and the rising edge of RCLK is less than t_{SKEW1} , then \overline{EF} may not change state until the next RCLK rising edge.

Switching Waveforms (continued)
Reset Timing^[14]

Notes:

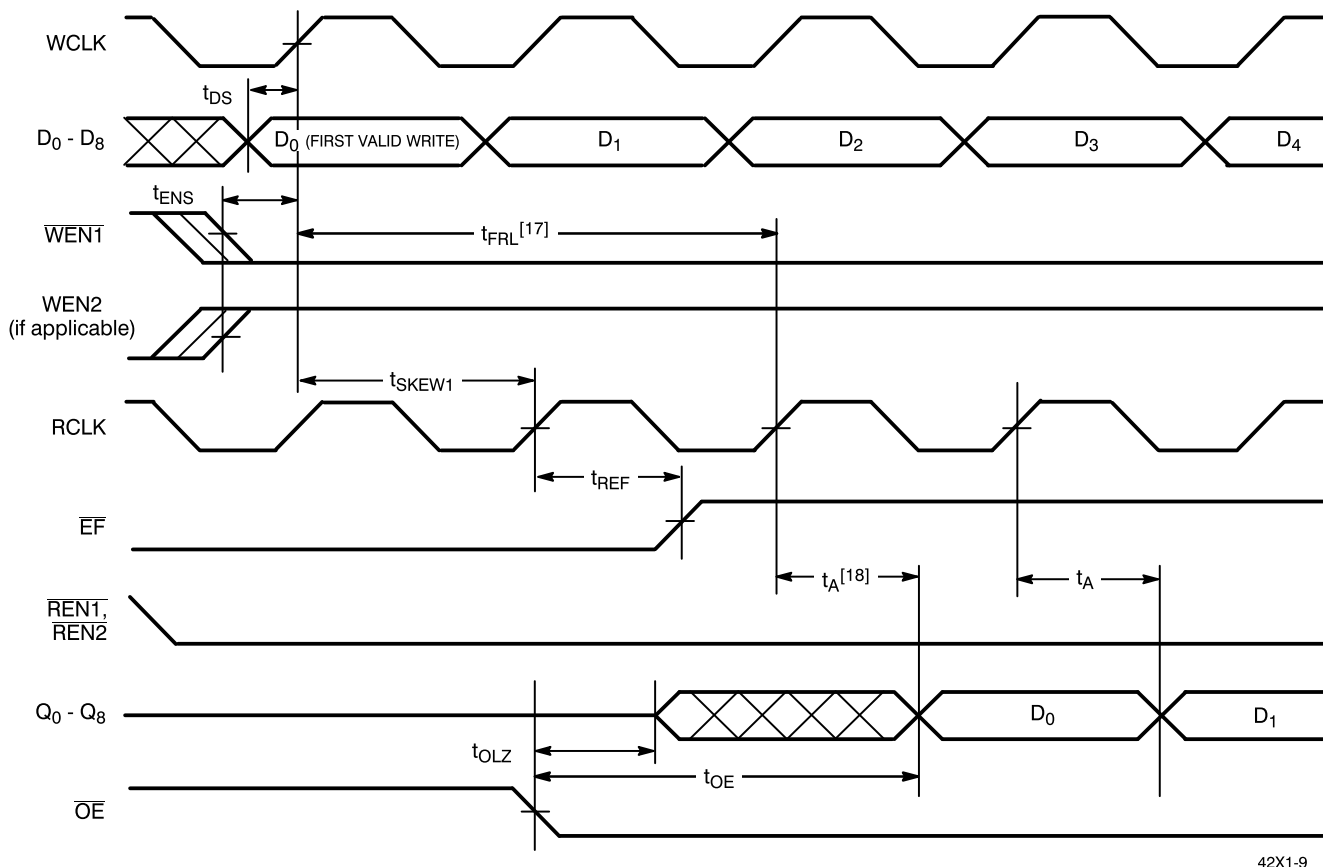
14. The clocks (RCLK, WCLK) can be free-running during reset.

15. After reset, the outputs will be LOW if $\overline{OE} = 0$ and three-state if $\overline{OE} = 1$.

16. Holding WEN2/ \overline{LD} HIGH during reset will make the pin act as a second enable pin. Holding WEN2/ \overline{LD} LOW during reset will make the pin act as a load enable for the programmable flag offset registers.

Switching Waveforms (continued)

First Data Word Latency after Reset with Simultaneous Read and Write

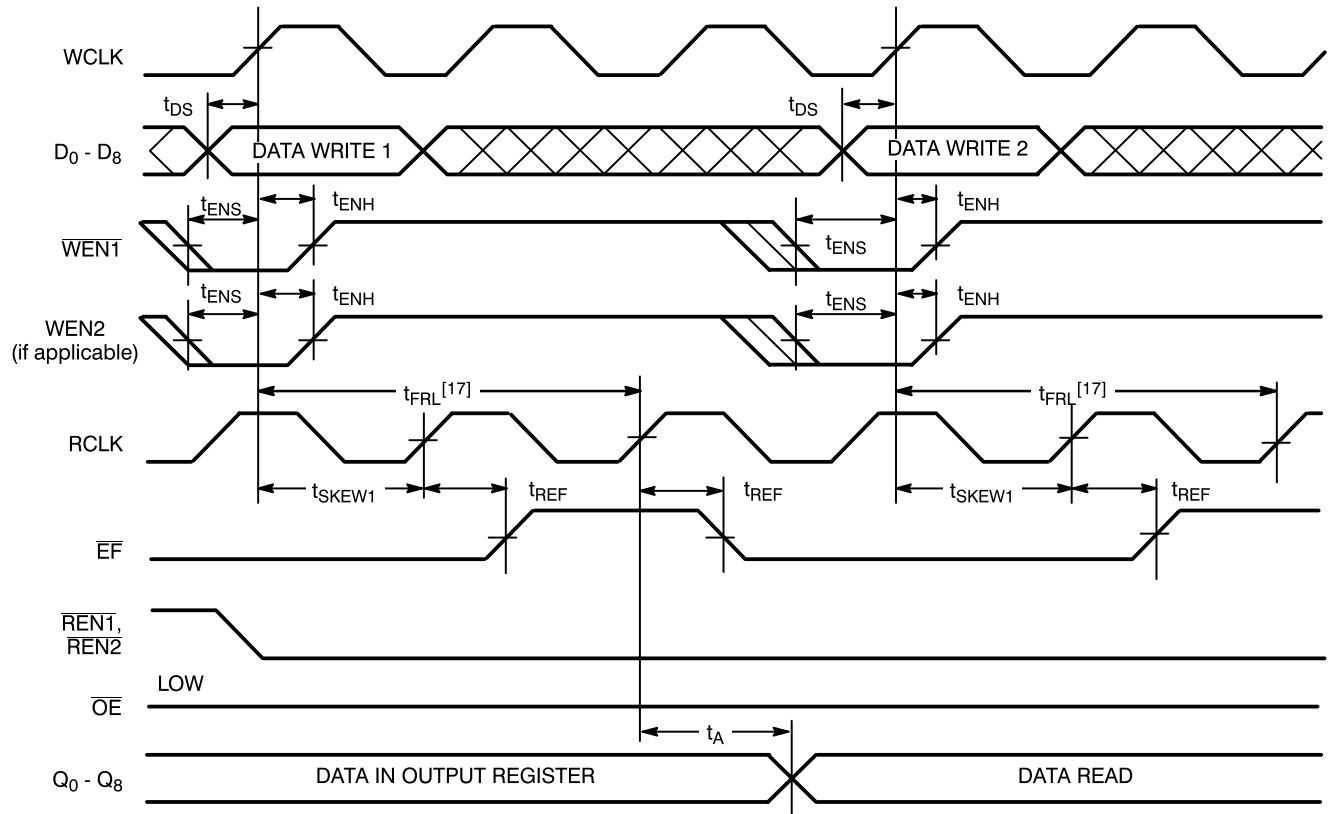


42X1-9

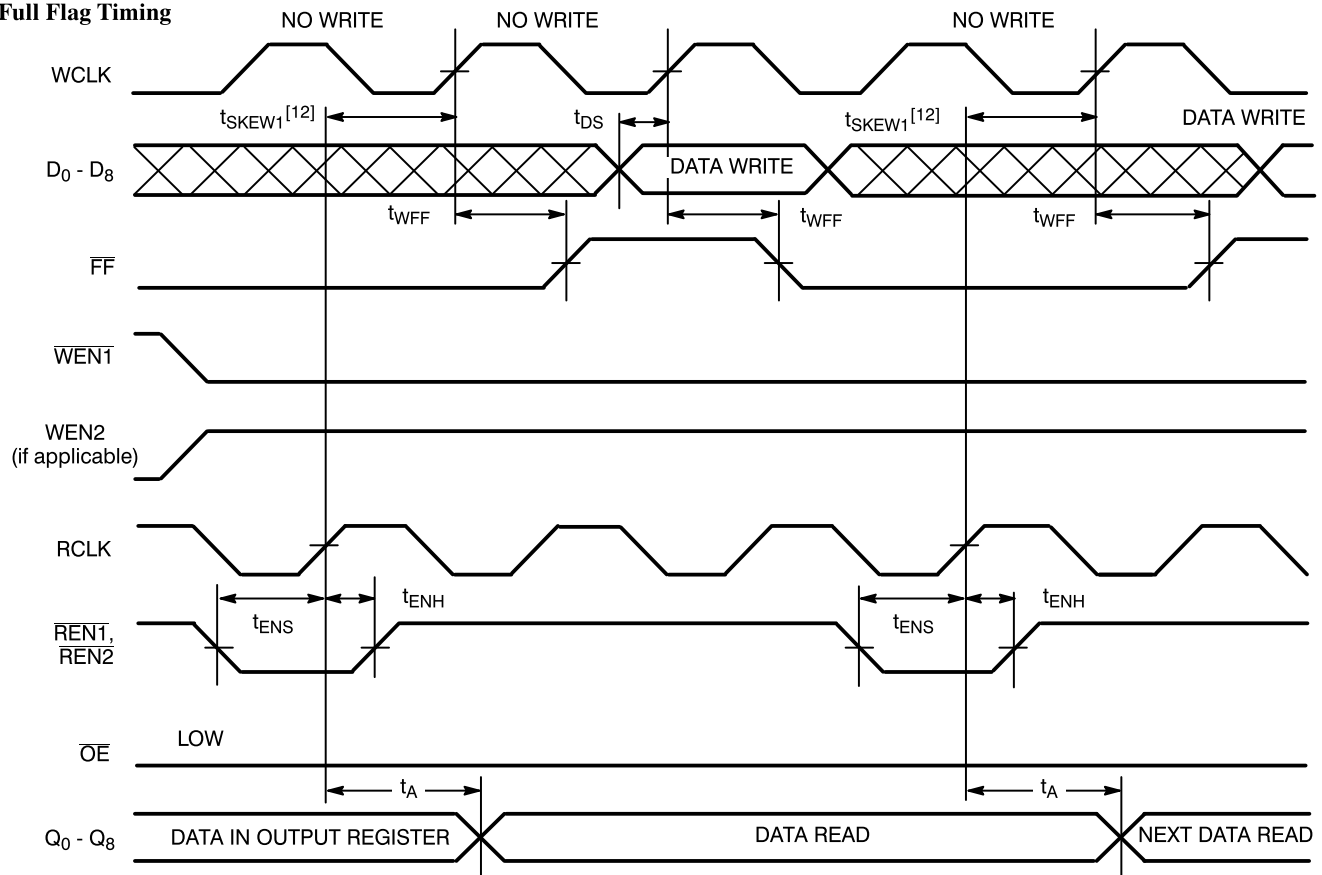
Notes:

17. When $t_{SKEW1} \geq$ minimum specification, t_{FRL} (maximum) = $t_{CLK} + t_{SKEW1}$. When $t_{SKEW1} <$ minimum specification, t_{FRL} (maximum) = either $2 \cdot t_{CLK} + t_{SKEW1}$ or $t_{CLK} + t_{SKEW1}$. The Latency Timing applies only at the Empty Boundary ($EF = LOW$).

18. The first word is available the cycle after EF goes HIGH, always.

Switching Waveforms (continued)
Empty Flag Timing


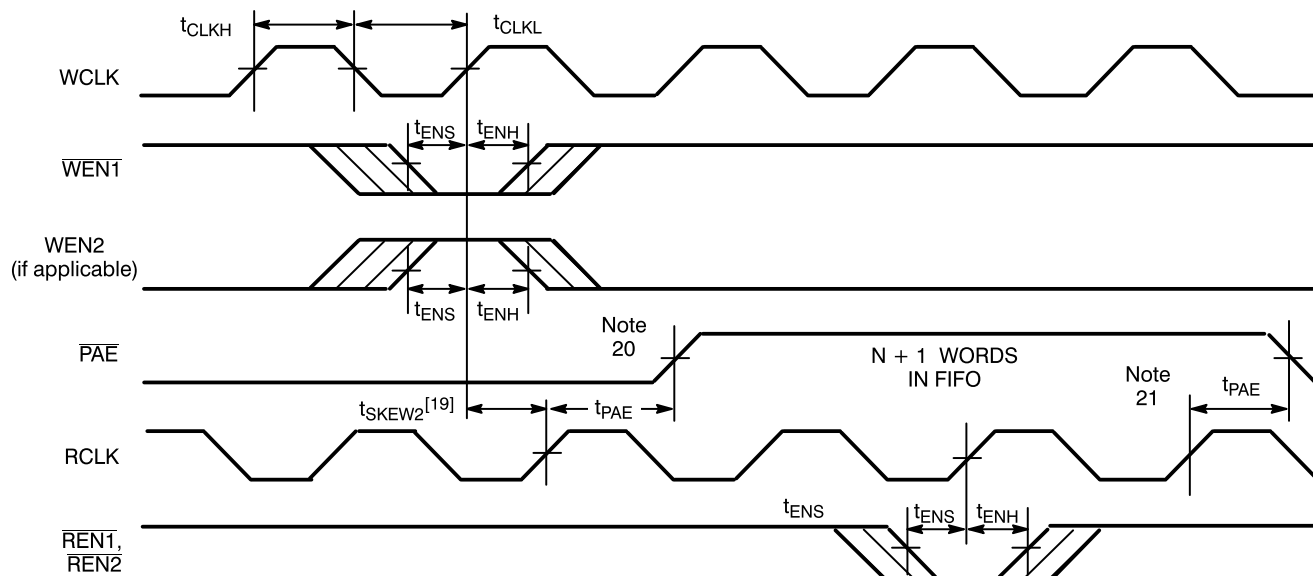
42X1-10

Switching Waveforms (continued)
Full Flag Timing


42X1-11

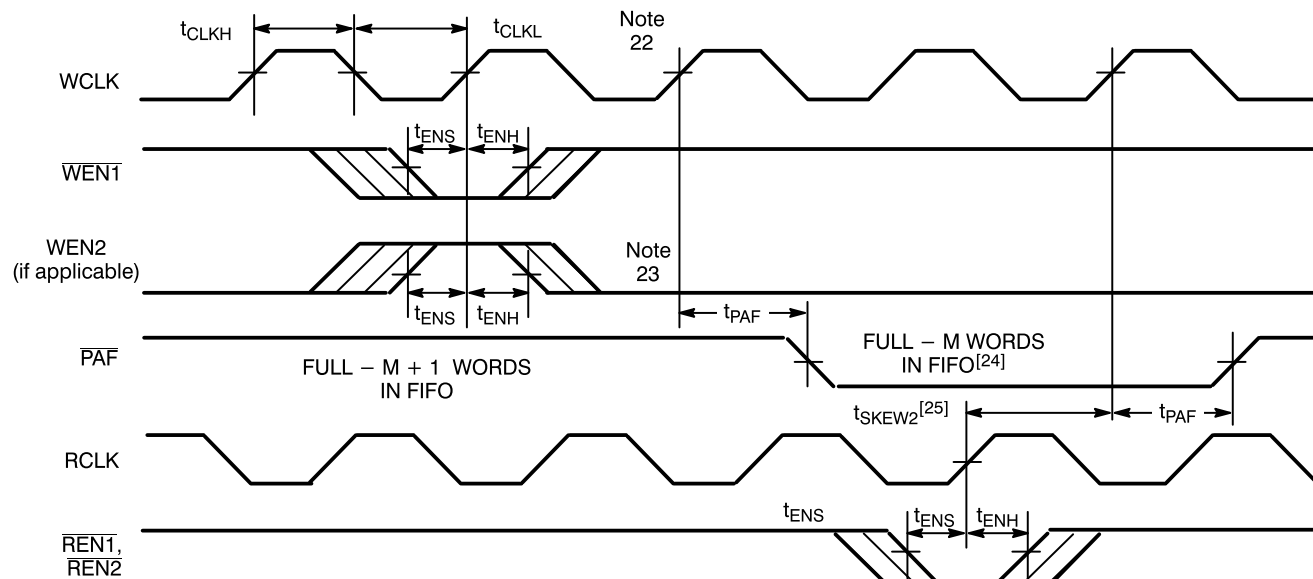
Switching Waveforms (continued)

Programmable Almost Empty Flag Timing



42X1-12

Programmable Almost Full Flag Timing



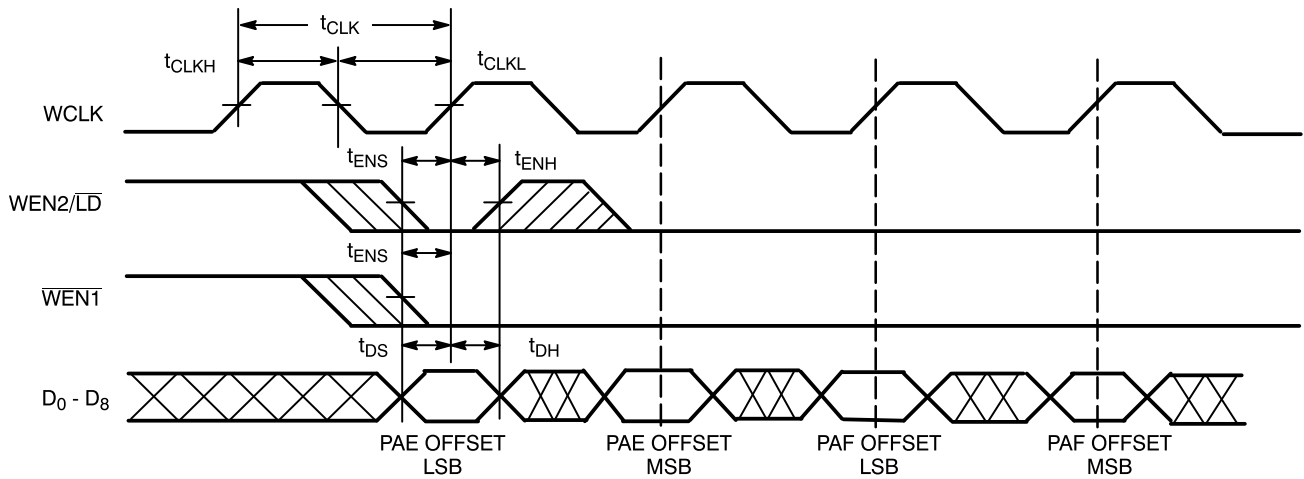
42X1-13

Notes:

19. t_{SKEW2} is the minimum time between a rising WCLK and a rising RCLK edge for PAE to change state during that clock cycle. If the time between the edge of WCLK and the rising RCLK is less than t_{SKEW2} , then PAE may not change state until the next RCLK.
20. PAE offset = n.
21. If a read is performed on this rising edge of the read clock, there will be Empty + (n - 1) words in the FIFO when PAE goes LOW.
22. If a write is performed on this rising edge of the write clock, there will be Full - (m - 1) words of the FIFO when PAF goes LOW.
23. PAF offset = m.
24. 64-m words for CY7C4421, 256-m words in FIFO for CY7C4201, 512-m words for CY7C4211, 1024-m words for CY7C4221, 2048-m words for CY7C4231, 4096-m words for CY7C4241, 8192-m words for CY7C4251.
25. t_{SKEW2} is the minimum time between a rising RCLK edge and a rising WCLK edge for PAF to change during that clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than t_{SKEW2} , then PAF may not change state until the next WCLK.

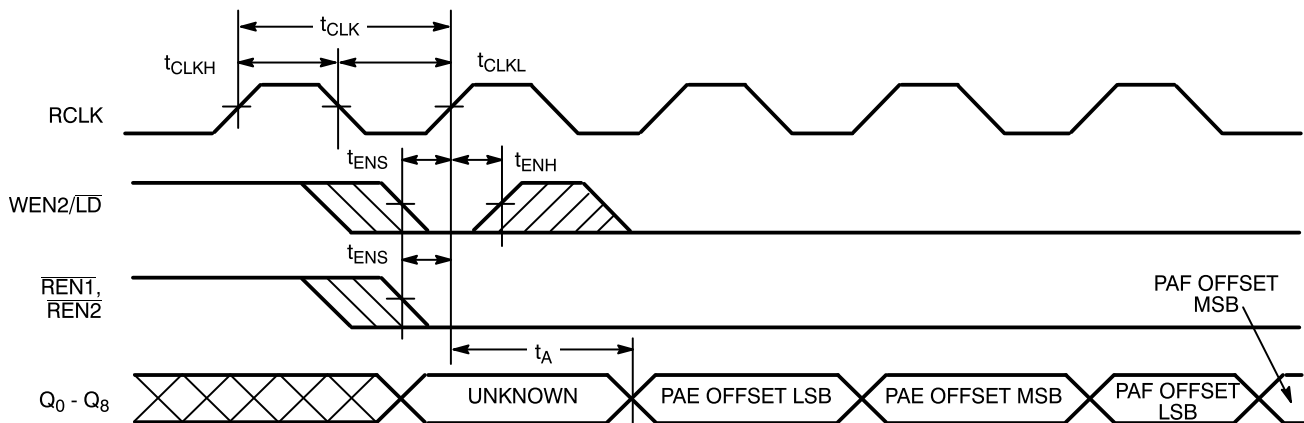
Switching Waveforms (continued)

Write Programmable Registers



42X1-14

Read Programmable Registers



42X1-15

Architecture

The CY7C42X1 consists of an array of 64 to 8K words of 9 bits each (implemented by a dual-port array of SRAM cells), a read pointer, a write pointer, control signals (RCLK, WCLK, REN1, REN2, WEN1, WEN2, RS), and flags (EF, PAE, PAF, FF).

Resetting the FIFO

Upon power-up, the FIFO must be reset with a Reset (\overline{RS}) cycle. This causes the FIFO to enter the Empty condition signified by \overline{EF} being LOW. All data outputs (Q₀ – 8) go LOW t_{RSF} after the rising edge of \overline{RS} . In order for the FIFO to reset to its default state, a falling edge must occur on \overline{RS} and the user must not read or write while \overline{RS} is LOW. All flags are guaranteed to be valid t_{RSF} after \overline{RS} is taken LOW.

FIFO Operation

When the $\overline{WEN1}$ signal is active LOW and WEN2 is active HIGH, data present on the D₀ – 8 pins is written into the FIFO on each rising edge of the WCLK signal. Similarly, when the $\overline{REN1}$ and $\overline{REN2}$ signals are active LOW, data in the FIFO memory will be presented on the Q₀ – 8 outputs. New data will be presented

on each rising edge of RCLK while $\overline{REN1}$ and $\overline{REN2}$ are active. $\overline{REN1}$ and $\overline{REN2}$ must set up t_{ENS} before RCLK for it to be a valid read function. $\overline{WEN1}$ and WEN2 must occur t_{ENS} before WCLK for it to be a valid write function.

An output enable (\overline{OE}) pin is provided to three-state the Q₀ – 8 outputs when \overline{OE} is asserted. When \overline{OE} is enabled (LOW), data in the output register will be available to the Q₀ – 8 outputs after t_{OE} .

The FIFO contains overflow circuitry to disallow additional writes when the FIFO is full, and underflow circuitry to disallow additional reads when the FIFO is empty. An empty FIFO maintains the data of the last valid read on its Q₀ – 8 outputs even after additional reads occur.

Write Enable 1 ($\overline{WEN1}$) – If the FIFO is configured for programmable flags, Write Enable 1 ($\overline{WEN1}$) is the only write enable control pin. In this configuration, when Write Enable 1 ($\overline{WEN1}$) is LOW, data can be loaded into the input register and RAM array on the LOW-to-HIGH transition of every write clock (WCLK). Data is stored in the RAM array sequentially and independently of any on-going read operation.

Write Enable 2/Load (WEN2/ \overline{LD}) – This is a dual-purpose pin. The FIFO is configured at Reset to have programmable flags or to have two write enables, which allows for depth expansion. If Write Enable 2/Load (WEN2/ \overline{LD}) is set active HIGH at Reset (\overline{RS} =LOW), this pin operates as a second write enable pin.

If the FIFO is configured to have two write enables, when Write Enable ($\overline{WEN1}$) is LOW and Write Enable 2/Load (WEN2/ \overline{LD}) is HIGH, data can be loaded into the input register and RAM array on the LOW-to-HIGH transition of every write clock (WCLK). Data is stored in the RAM array sequentially and independently of any on-going read operation.

Programming

When WEN2/ \overline{LD} is held LOW during Reset, this pin is the load (\overline{LD}) enable for flag offset programming. In this configuration, WEN2/ \overline{LD} can be used to access the four 8-bit offset registers contained in the CY7C42X1 for writing or reading data to these registers.

When the device is configured for programmable flags and both WEN2/ \overline{LD} and $\overline{WEN1}$ are LOW, the first LOW-to-HIGH transition of WCLK writes data from the data inputs to the empty offset least significant bit (LSB) register. The second, third, and fourth LOW-to-HIGH transitions of WCLK store data in the empty offset most significant bit (MSB) register, full offset LSB register, and full offset MSB register, respectively, when WEN2/ \overline{LD} and $\overline{WEN1}$ are LOW. The fifth LOW-to-HIGH transition of WCLK while WEN2/ \overline{LD} and $\overline{WEN1}$ are LOW writes data to the empty LSB register again. Figure 1 shows the registers sizes and default values for the various device types.

It is not necessary to write to all the offset registers at one time. A subset of the offset registers can be written; then by bringing the WEN2/ \overline{LD} input HIGH, the FIFO is returned to normal read and write operation. The next time WEN2/ \overline{LD} is brought LOW, a write operation stores data in the next offset register in sequence.

The contents of the offset registers can be read to the data outputs when WEN2/ \overline{LD} is LOW and both $\overline{REN1}$ and $\overline{REN2}$ are LOW. LOW-to-HIGH transitions of RCLK read register contents to the

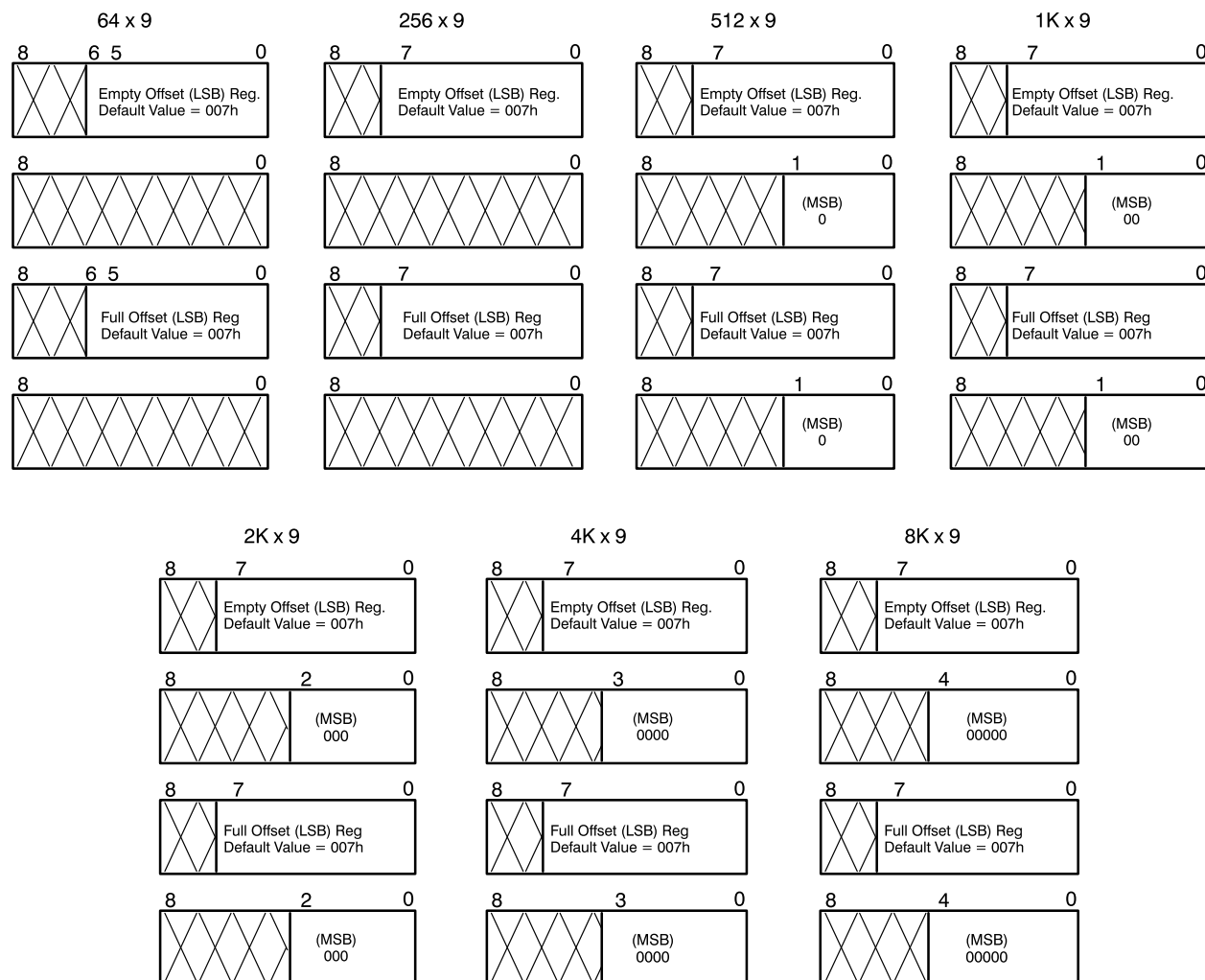






Figure 1. Offset Register Location and Default Values

data outputs. Writes and reads should not be performed simultaneously on the offset registers.

Programmable Flag (PAE, PAF) Operation

Whether the flag offset registers are programmed as described in *Table 1* or the default values are used, the programmable almost-empty flag (PAE) and programmable almost-full flag (PAF) states are determined by their corresponding offset registers and the difference between the read and write pointers.

Table 1. Writing the Offset Registers

$\overline{\text{LD}}$	$\overline{\text{WEN}}$	WCLK ^[26]	Selection
0	0		Empty Offset (LSB) ← Empty Offset (MSB) → Full Offset (LSB) Full Offset (MSB)
0	1		No Operation
1	0		Write Into FIFO
1	1		No Operation

The number formed by the empty offset least significant bit register and empty offset most significant bit register is referred to as n and determines the operation of $\overline{\text{PAE}}$. $\overline{\text{PAE}}$ is synchronized to the LOW-to-HIGH transition of RCLK by one flip-flop and is LOW when the FIFO contains n or fewer unread words. $\overline{\text{PAE}}$ is set HIGH by the LOW-to-HIGH transition of RCLK when the FIFO contains $(n+1)$ or greater unread words.

The number formed by the full offset least significant bit register and full offset most significant bit register is referred to as m and determines the operation of $\overline{\text{PAF}}$. $\overline{\text{PAF}}$ is synchronized to the LOW-to-HIGH transition of WCLK by one flip-flop and is set LOW when the number of unread words in the FIFO is greater than or equal to CY7C4421. (64– m), CY7C4201 (256– m), CY7C4211 (512– m), CY7C4221 (1K– m), CY7C4231 (2K– m), CY7C4241 (4K– m), and CY7C4251 (8K– m). $\overline{\text{PAF}}$ is set HIGH by the LOW-to-HIGH transition of WCLK when the number of available memory locations is greater than m .

Table 2. Status Flags

Number of Words in FIFO			$\overline{\text{FF}}$	$\overline{\text{PAF}}$	$\overline{\text{PAE}}$	$\overline{\text{EF}}$
CY7C4421	CY7C4201	CY7C4211				
0	0	0	H	H	L	L
1 to $n^{[27]}$	1 to $n^{[27]}$	1 to $n^{[27]}$	H	H	L	H
$(n+1)$ to 32	$(n+1)$ to 128	$(n+1)$ to 256	H	H	H	H
33 to $(64 - (m+1))$	129 to $(256 - (m+1))$	257 to $(512 - (m+1))$	H	H	H	H
$(64 - m)^{[28]}$ to 63	$(256 - m)^{[28]}$ to 255	$(512 - m)^{[28]}$ to 511	H	L	H	H
64	256	512	L	L	H	H

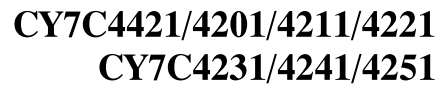
Number of Words in FIFO				$\overline{\text{FF}}$	$\overline{\text{PAF}}$	$\overline{\text{PAE}}$	$\overline{\text{EF}}$
CY7C4221	CY7C4231	CY7C4241	CY7C4251				
0	0	0	0	H	H	L	L
1 to $n^{[27]}$	1 to $n^{[27]}$	1 to $n^{[27]}$	1 to $n^{[27]}$	H	H	L	H
$(n+1)$ to 512	$(n+1)$ to 1024	$(n+1)$ to 2048	$(n+1)$ to 4096	H	H	H	H
513 to $(1024 - (m+1))$	1025 to $(2048 - (m+1))$	2049 to $(4096 - (m+1))$	4097 to $(8192 - (m+1))$	H	H	H	H
$(1024 - m)^{[28]}$ to 1023	$(2048 - m)^{[28]}$ to 2047	$(4096 - m)^{[28]}$ to 4095	$(8192 - m)^{[28]}$ to 8191	H	L	H	H
1024	2048	4096	8192	L	L	H	H

Notes:

26. The same selection sequence applies to reading from the registers. $\overline{\text{REN1}}$ and $\overline{\text{REN2}}$ are enabled and a read is performed on the LOW-to-HIGH transition of RCLK.

27. n = Empty Offset ($n=7$ default value).

28. m = Full Offset ($m=7$ default value).



Flag Operation

The CY7C42X5 devices provide five flag pins to indicate the condition of the FIFO contents. Empty, Full, PAE, and $\overline{\text{PAF}}$ are synchronous.

Full Flag

Empty Flag

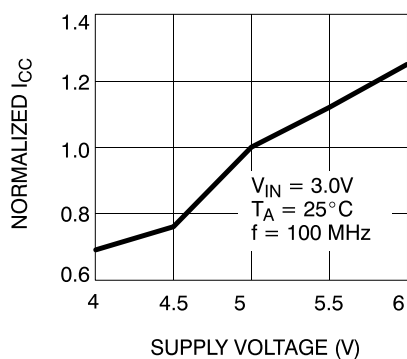
The Empty Flag ($\overline{\text{EF}}$) will go LOW when the device is empty. Read operations are inhibited whenever $\overline{\text{EF}}$ is LOW, regardless of the state of $\overline{\text{REN1}}$ and $\overline{\text{REN2}}$. $\overline{\text{EF}}$ is synchronized to RCLK, i.e., it is exclusively updated by each rising edge of RCLK.



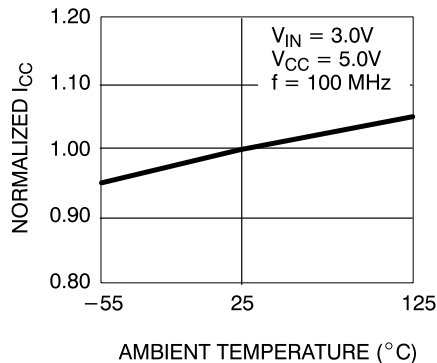
15

Typical AC and DC Characteristics

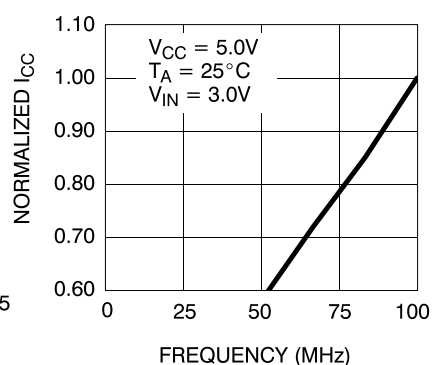
**NORMALIZED SUPPLY CURRENT
vs. SUPPLY VOLTAGE**



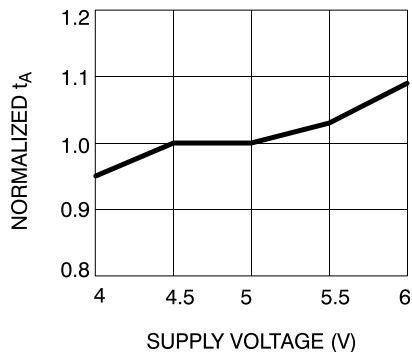
**NORMALIZED SUPPLY CURRENT
vs. AMBIENT TEMPERATURE**



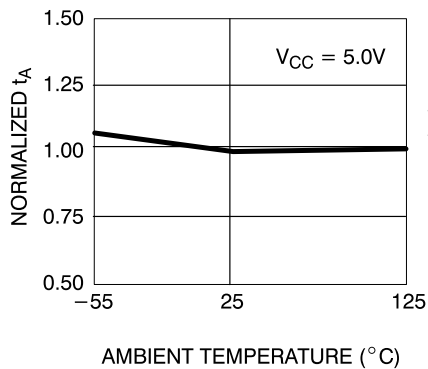
**NORMALIZED SUPPLY CURRENT
vs. FREQUENCY**



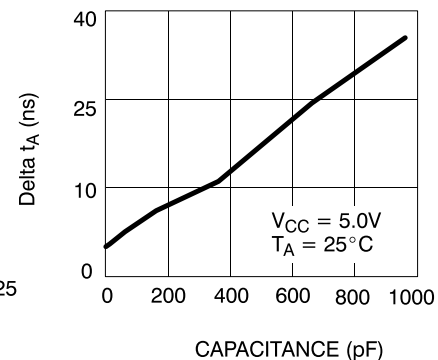
**NORMALIZED t_A vs. SUPPLY
VOLTAGE**



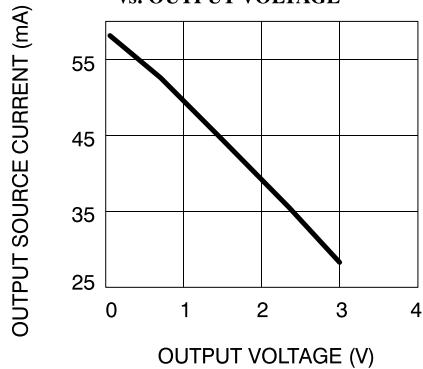
**NORMALIZED t_A vs.
AMBIENT TEMPERATURE**



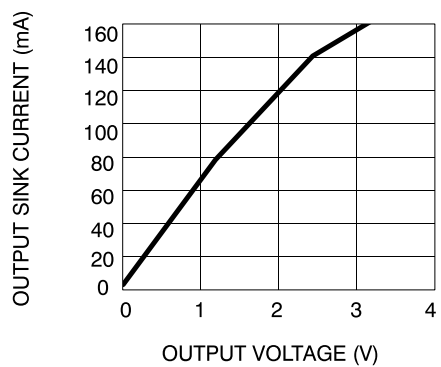
**TYPICAL t_A CHANGE vs.
OUTPUT LOADING**



**OUTPUT SOURCE CURRENT
vs. OUTPUT VOLTAGE**



**OUTPUT SINK CURRENT vs.
OUTPUT VOLTAGE**





Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4421-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4421-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4421-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4421-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4421-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4421-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4421-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4421-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4421-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4421-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4421-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4421-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4421-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4421-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4421-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4421-35JI	J65	32-Lead Plastic Leaded Chip Carrier	

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4201-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4201-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4201-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4201-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4201-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4201-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4201-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4201-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4201-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4201-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4201-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4201-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4201-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4201-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4201-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4201-35JI	J65	32-Lead Plastic Leaded Chip Carrier	

Ordering Information (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4211-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4211-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4211-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4211-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4211-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4211-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4211-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4211-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4211-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4211-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4211-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4211-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4211-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4211-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4211-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4211-35JI	J65	32-Lead Plastic Leaded Chip Carrier	

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4221-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4221-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4221-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4221-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4221-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4221-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4221-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4221-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4221-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4221-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4221-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4221-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4221-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4221-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4221-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4221-35JI	J65	32-Lead Plastic Leaded Chip Carrier	



Ordering Information (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4231-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4231-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4231-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4231-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4231-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4231-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4231-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4231-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4231-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4231-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4231-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4231-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4231-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4231-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4231-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4231-35JI	J65	32-Lead Plastic Leaded Chip Carrier	

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4241-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4241-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4241-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4241-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4241-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4241-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4241-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4241-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4241-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4241-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4241-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4241-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4241-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4241-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4241-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4241-35JI	J65	32-Lead Plastic Leaded Chip Carrier	



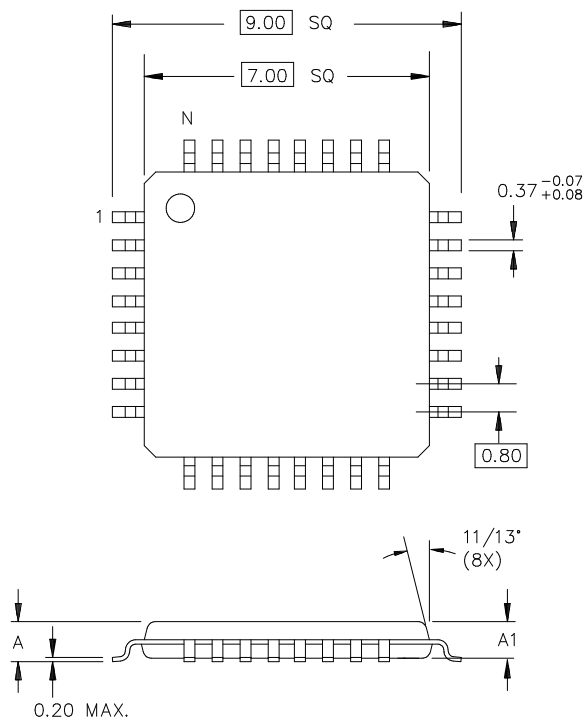
Ordering Information (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4251-10AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4251-10JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4251-10AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4251-10JI	J65	32-Lead Plastic Leaded Chip Carrier	
15	CY7C4251-15AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4251-15JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4251-15AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4251-15JI	J65	32-Lead Plastic Leaded Chip Carrier	
25	CY7C4251-25AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4251-25JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4251-25AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4251-25JI	J65	32-Lead Plastic Leaded Chip Carrier	
35	CY7C4251-35AC	A32	32-Lead Thin Quad Flatpack	Commercial
	CY7C4251-35JC	J65	32-Lead Plastic Leaded Chip Carrier	
	CY7C4251-35AI	A32	32-Lead Thin Quad Flatpack	Industrial
	CY7C4251-35JI	J65	32-Lead Plastic Leaded Chip Carrier	

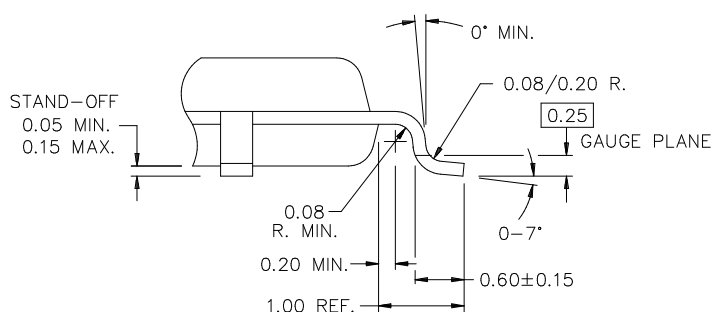
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Package Diagrams

32-Lead Thin Plastic Quad Flat Pack A32



DIMENSIONS IN MILLIMETERS
LEAD COPLANARITY 0.080 MAX.



DIM. A	DIM. A1
1.60 MAX.	1.40 ± 0.05 PKG. THICK
1.20 MAX.	1.00 ± 0.05 PKG. THICK

32-Lead Plastic Leaded Chip Carrier J65

DIMENSIONS IN INCHES $\frac{\text{MIN.}}{\text{MAX.}}$

